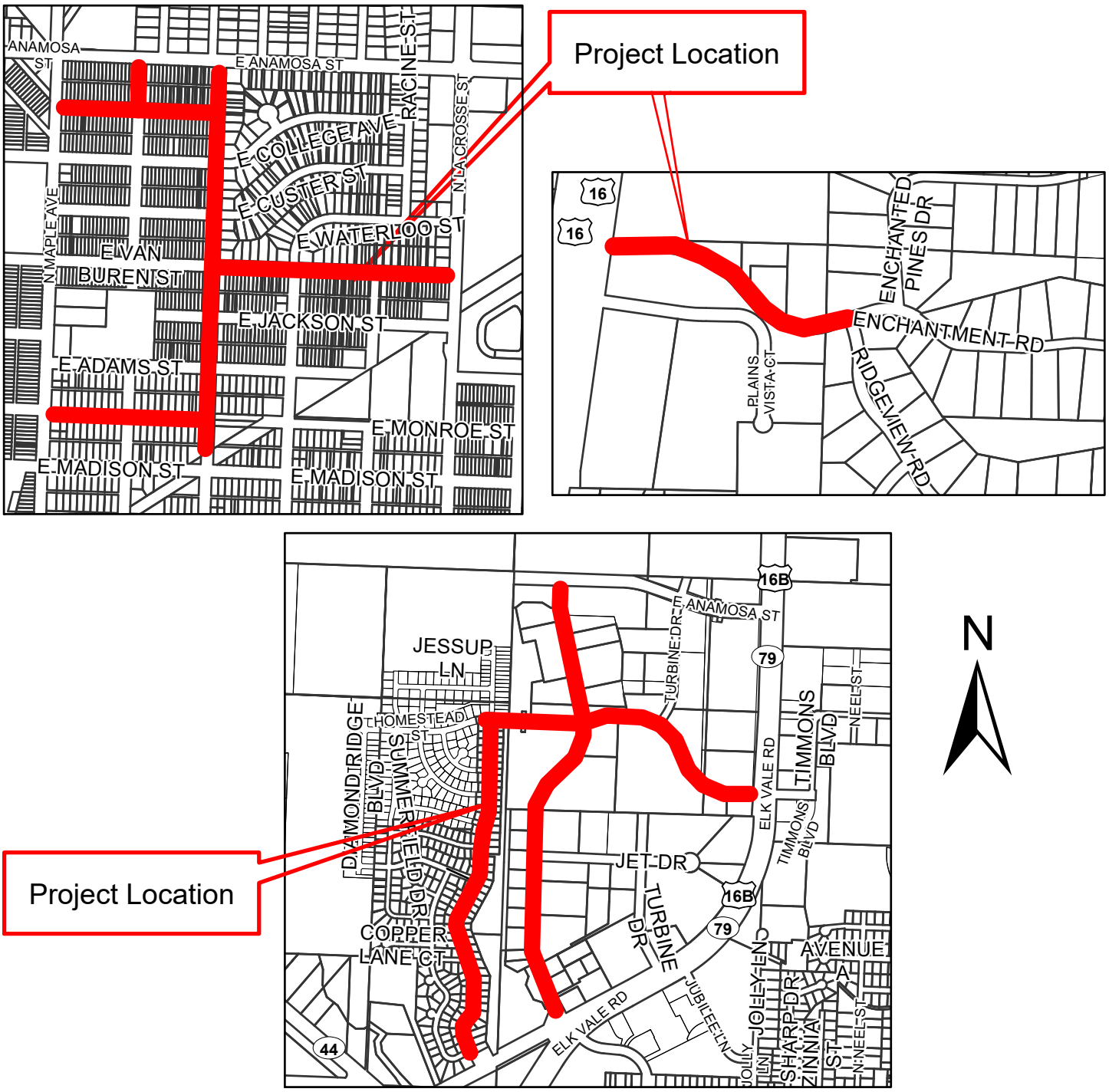
Project Location Map



2021 Chip Seal Project
Project No. 19-2620
CIP No. 50549